TOSHIBA Field Effect Transistor Silicon N-Channel MOS Type (π -MOSVI)

2SK3935

Switching Regulator Applications

• Low drain-source ON resistance: $R_{DS(ON)} = 0.18 \Omega \text{ (typ.)}$

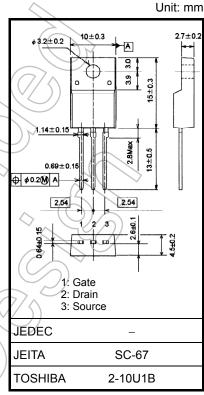
High forward transfer admittance: |Y_{fs}| = 10 S (typ.)

• Low leakage current: I_{DSS} = 100 μA (max) (V_{DS} = 450 V)

• Enhancement model: V_{th} = 2.0 to 4.0 V (V_{DS} = 10 V, I_D = 1 mA)

Absolute Maximum Ratings (Ta = 25°C)

Characteri	stic	Symbol	Rating	Unit
Drain-source voltage		V_{DSS}	450	(\sqrt{y}/\sqrt{x})
Drain-gate voltage (RG	_S = 20 kΩ)	V_{DGR}	450	V
Gate-source voltage		V _{GSS}	±30	y
Drain current	DC (Note 1)	I _D	17	A
	Pulse(Note 1)	I _{DP}	68	Α
Drain power dissipation	1	P _D	50	W
Single pulse avalanche	e energy (Note 2)	EAS	919	mJ
Avalanche current		IAR	I _{AR} 17	
Repetitive avalanche e	nergy (Note 3)	E _{AR} 5		mJ
Channel temperature		(T _{ch}	150	∕ °c
Storage temperature ra	inge	T _{stg}	-55 to 150	7,¢



Weight: 1.7 g (typ.)

Note: Using continuously under heavy loads (e.g. the application of high temperature/current/voltage and the significant change in temperature, etc.) may cause this product to decrease in the reliability significantly even if the operating conditions (i.e. operating temperature/current/voltage, etc.) are within the absolute maximum ratings. Please design the appropriate reliability upon reviewing the Toshiba Semiconductor Reliability Handbook ("Handling Precautions"/"Derating Concept and Methods") and individual reliability data (i.e. reliability test report and estimated failure rate, etc).

Thermal Characteristics

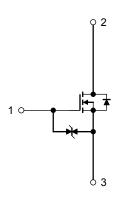
Characteristic	Symbol	Max	Unit
Thermal resistance, channel to case	R _{th (ch-c)}	2.5	°C/W
Thermal resistance, channel to ambient	R _{th (ch-a)}	62.5	°C/W

Note 1: Ensure that the channel temperature does not exceed 150°C during use of the device.

Note 2: $V_{DD} = 90 \text{ V}$, $T_{ch} = 25^{\circ}\text{C}$ (initial), L = 5.3 mH, $R_G = 25 \Omega$, $I_{AR} = 17 \text{ A}$

Note 3: Repetitive rating: pulse width limited by maximum channel temperature.

This transistor is an electrostatic-sensitive device. Handle with care.



Electrical Characteristics (Ta = 25°C)

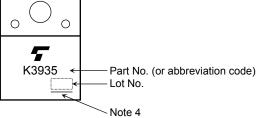
Chara	cteristic	Symbol	Test Condition	Min	Тур.	Max	Unit
Gate leakage cu	irrent	I _{GSS}	V _{GS} = ±25 V, V _{DS} = 0 V	_	_	±10	μΑ
Gate-source bre	akdown voltage	V (BR) GSS	I _G = ±10 μA, V _{DS} = 0 V	±30	_	_	V
Drain cutoff curr	ent	I _{DSS}	V _{DS} = 450 V, V _{GS} = 0 V	//	_	100	μΑ
Drain-source bre	eakdown voltage	V (BR) DSS	I _D = 10 mA, V _{GS} = 0 V	450	_	_	V
Gate threshold v	oltage	V _{th}	V _{DS} = 10 V, I _D = 1 mA	2.0) /_	4.0	V
Drain-source ON	N resistance	R _{DS} (ON)	V _{GS} = 10 V, I _D = 8.5 A) 	0.18	0.25	Ω
Forward transfer	r admittance	Y _{fs}	V _{DS} = 10 V, I _D = 8.5 A	2.6	10	_	S
Input capacitano	e	C _{iss}		_	3100	_	
Reverse transfer	r capacitance	C _{rss}	V _{DS} = 25 V, V _{GS} = 0 V, f = 1 MHz	_	20	_	pF
Output capacitance Cos		Coss		_	270	_	
Switching time Fa	Rise time	t _r	V _{GS} 0 V D = 8.5 A Output	- {	70	> I →	
	Turn-on time	t _{on}			130) _	ns
	Fall time	t _f	CO & III	9	70	_	113
	Turn-off time	t _{off}	Duty ≤ 1%, t _w = 10 μs) –	280		
Total gate charg plus gate-drain)	e (gate-source	Qg		_	62	_	
Gate-source cha	arge	Q _{gs}	$V_{DD} \approx 360 \text{ V}, V_{GS} = 10 \text{ V}, I_D = 17 \text{ A}$	_	40	_	nC
Gate-drain ("Mill	er") charge	Q _{gd}		_	22	_	

Source-Drain Ratings and Characteristics (Ta = 25°C)

Characteristic	Symbol	Test Condition	Min	Тур.	Max	Unit
Continuous drain reverse current (Note 1)	I _{DR}	_	_	_	17	Α
Pulse drain reverse current (Note 1)	I _{DRP}	_	_	_	68	Α
Forward voltage (diode)	V _{DSF}	I _{DR} = 17 A, V _{GS} = 0 V	_	_	-1.7	V
Reverse recovery time	t _{rr}	I _{DR} = 17 A, V _{GS} = 0 V	_	1400		ns
Reverse recovery charge	Qrr	dl _{DR} / dt = 100 Å / μs	_	21		μС

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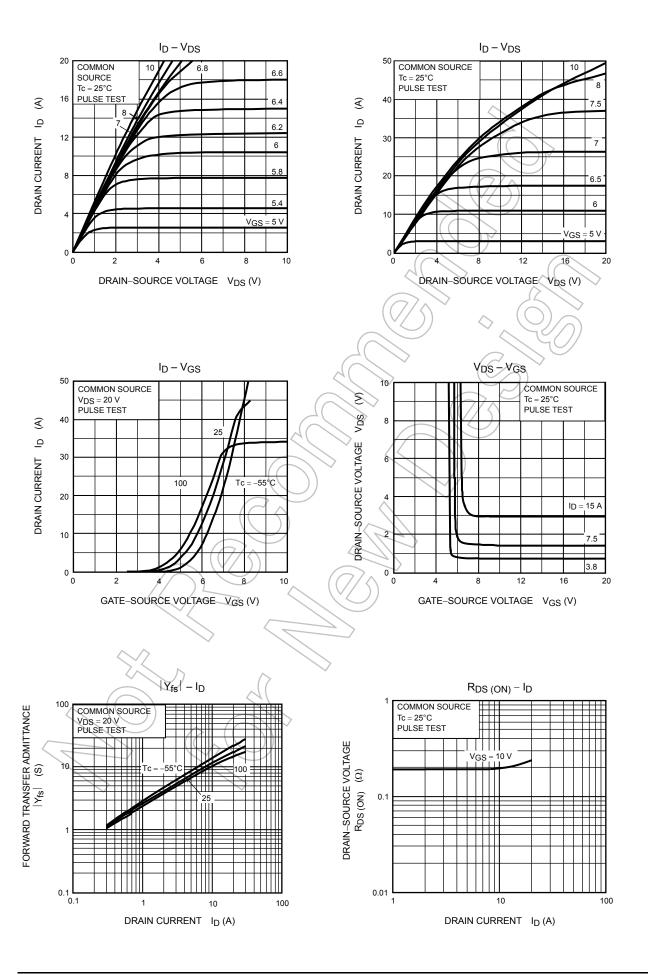


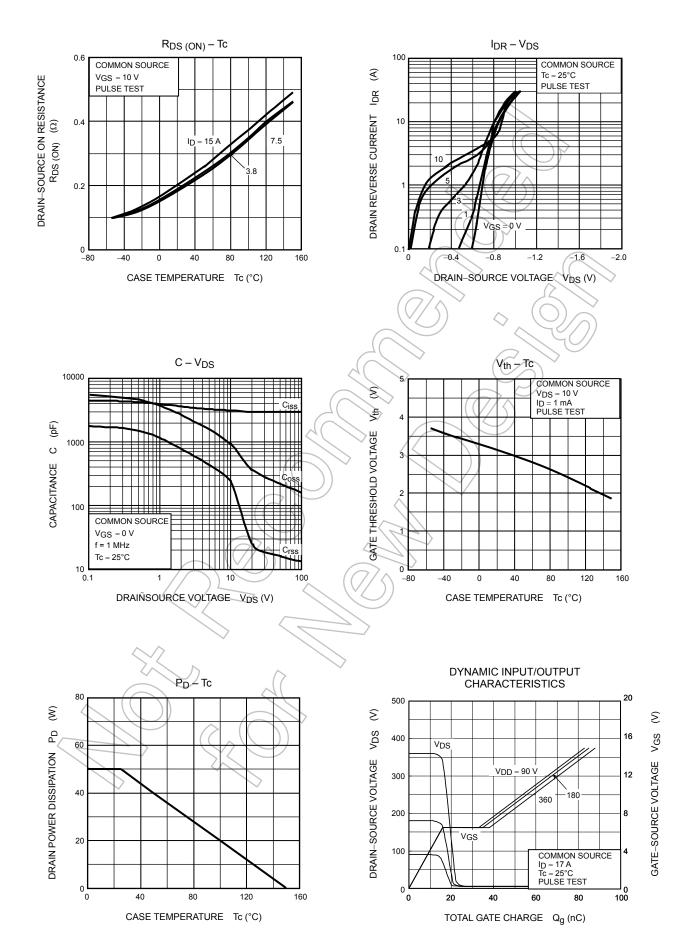


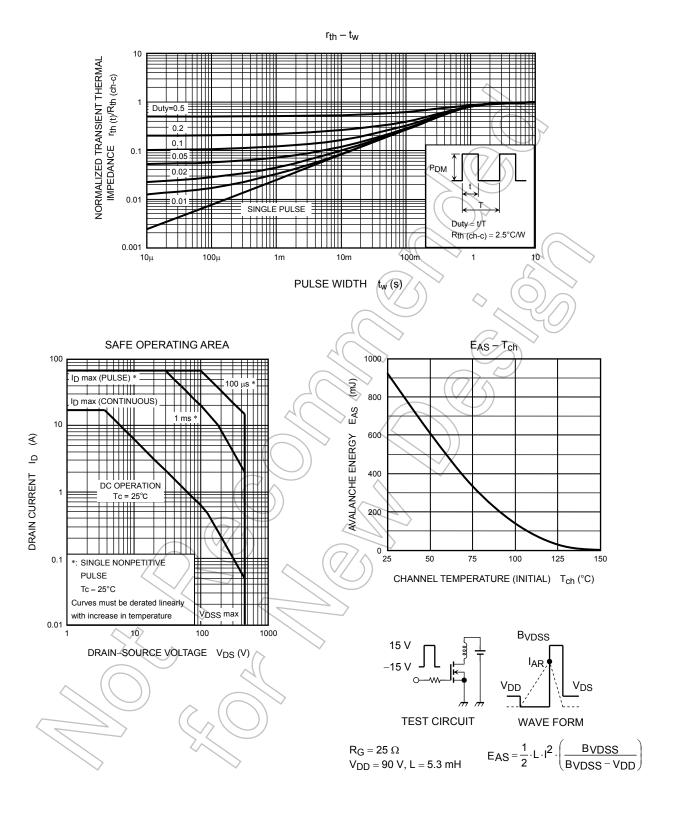
Note 4: A line under a Lot No. identifies the indication of product Labels.

[[G]]/RoHS COMPATIBLE or [[G]]/RoHS [[Pb]]

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